

# High Power Couplers and HOM Couplers Developments for High Intensity Applications

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Electron-Ion Collider

# Outline

## I. High power coupler development

- High power FPC evolution.
- EIC development of 1 MW (TW) wide-bandwidth high-power coupler

## II. HOM coupler development

- Overview of existing HOM dampers
- EIC development of beamline SiC HOM damper

## III. Closing comments

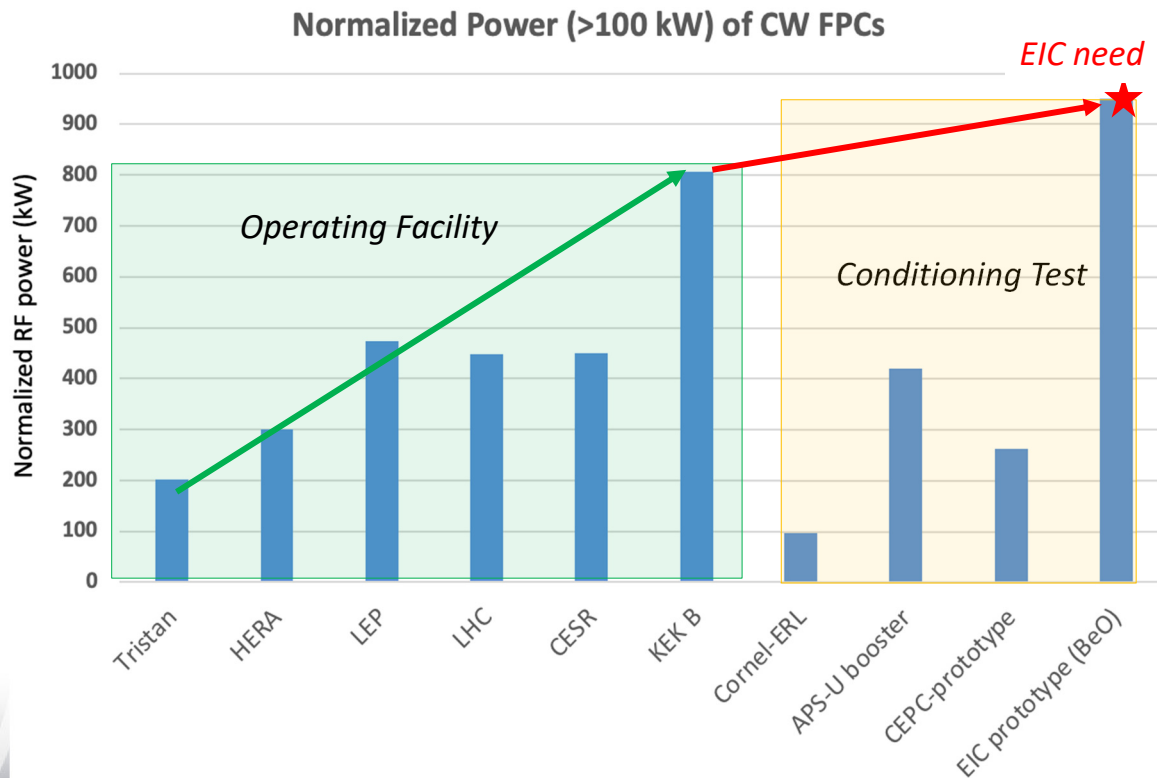
*Note: In this presentation I focus on recent developments. There are many excellent FPC and HOM coupler/damper reviews in the SRF conference proceedings and USPAS classes which I cite in my paper contribution.*

# Normalized power of FPCs

- *New FPCs are based on previous worldwide and evolving experience.*
- **Normalize FPC power**
  - *Transmission line RF losses dominate heating, although RF window is the weak point.*
  - *Need to consider both frequency and power when comparing different couplers.*
  - *Here I use:*

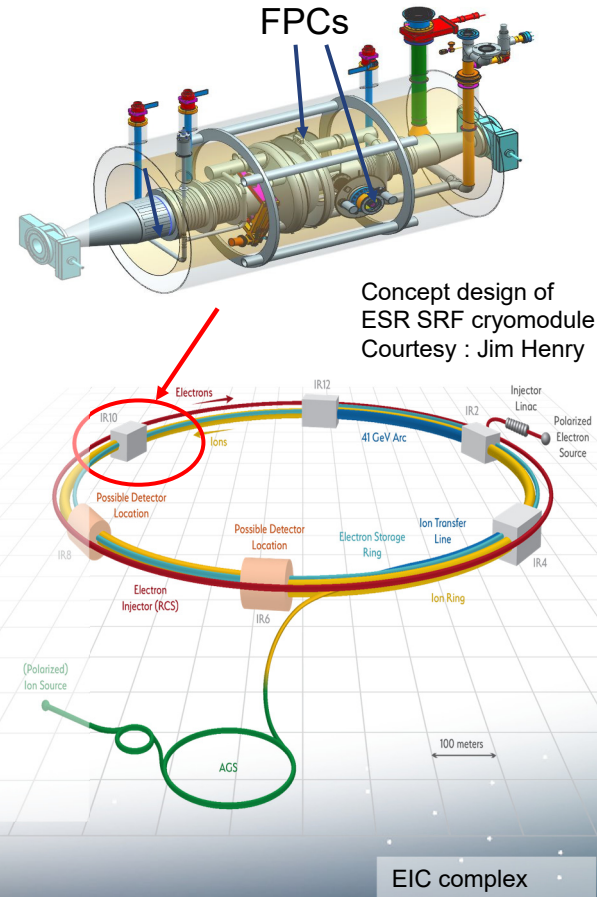
$$\text{Power} \times \sqrt{\text{freq}[\text{MHz}]/500} \text{ [kW]}$$

- **EIC eSR FPCs to operate at MW level of normalized power.**



# FPC for EIC ESR SRF cavity

- *The highest power coupler for all EIC SRF/RF cavities are the couplers for eSRF SRF cavity*
  - *Frequency: 591 MHz*
  - *CW 380 kW per coupler, 2 couplers per cavity*
  - *Abort gap:*
    - *92% TW operation*
    - *8% full reflection*
- *FPC design/testing criteria*
  - *CW 1 MW (TW) or 500 kW (SW)*
- *MW FPC R&D status*
  - *BeO RF windows successful up to ~500 kW (SW), but need improved reliability and easier handling.*
  - *A new alumina (99.5%) RF window FPC is being developed.*

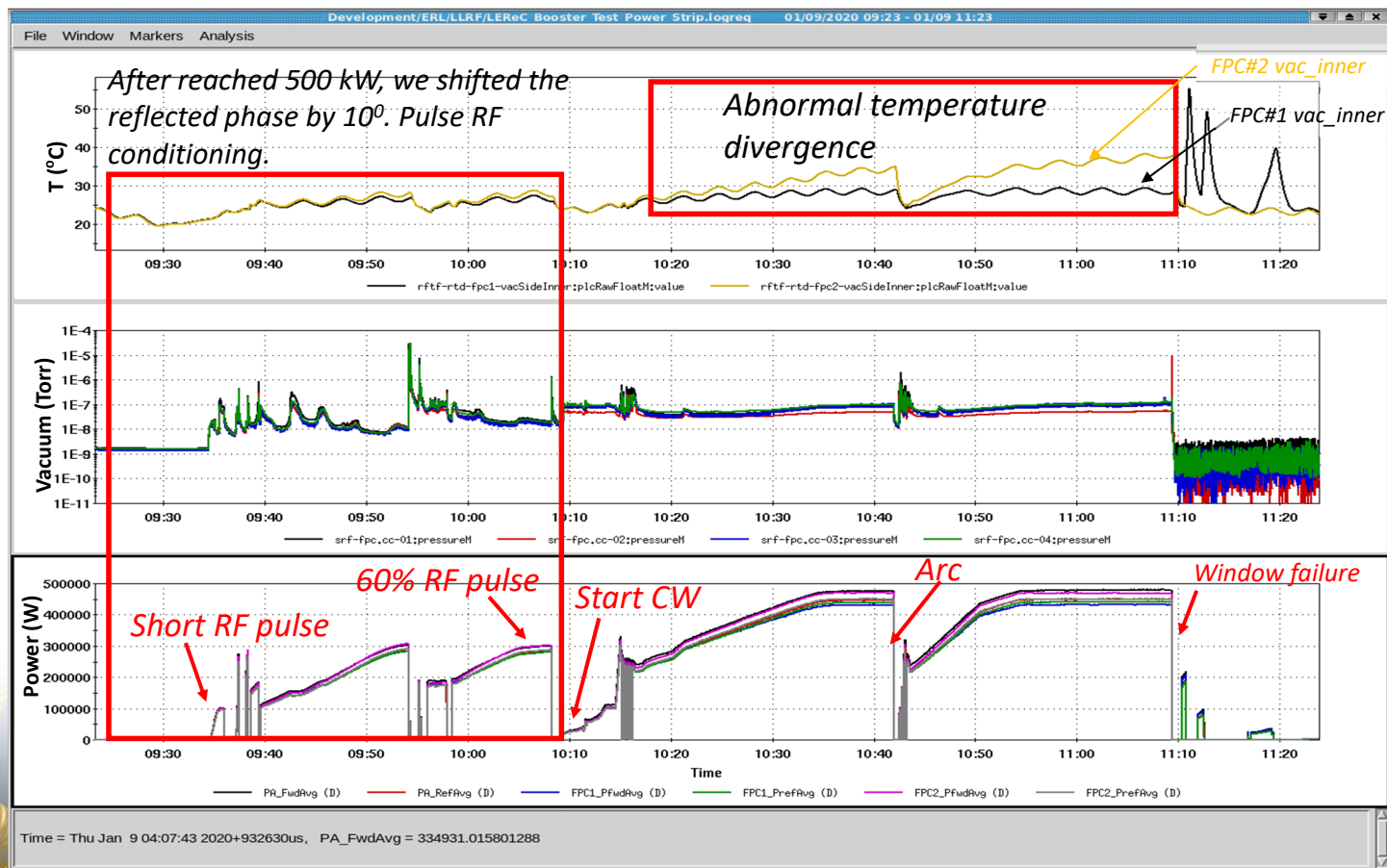


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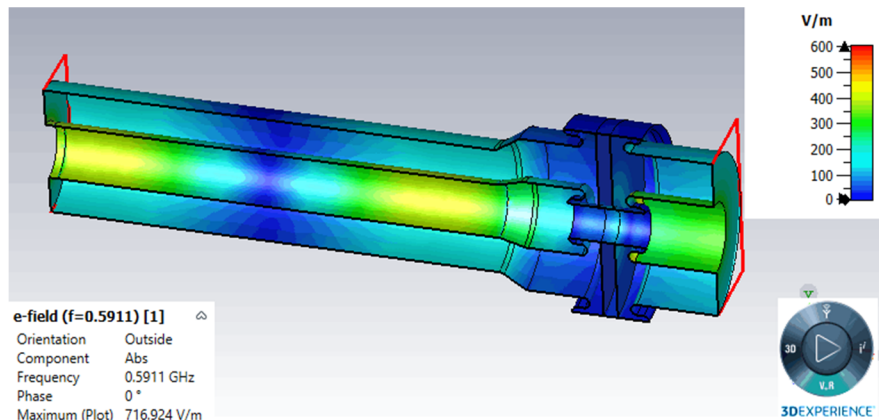


# High Power FPC w/ BeO RF Window Test

- BeO window FPC test
  - Successful CW 400 kW, SW, all phases.
  - Successful CW 500 kW, SW, at one phase.
  - Window failure at second phase, due to arcing in FPC airside
- BeO FPC demonstrated feasibility of EIC operating power level, proof of principle.

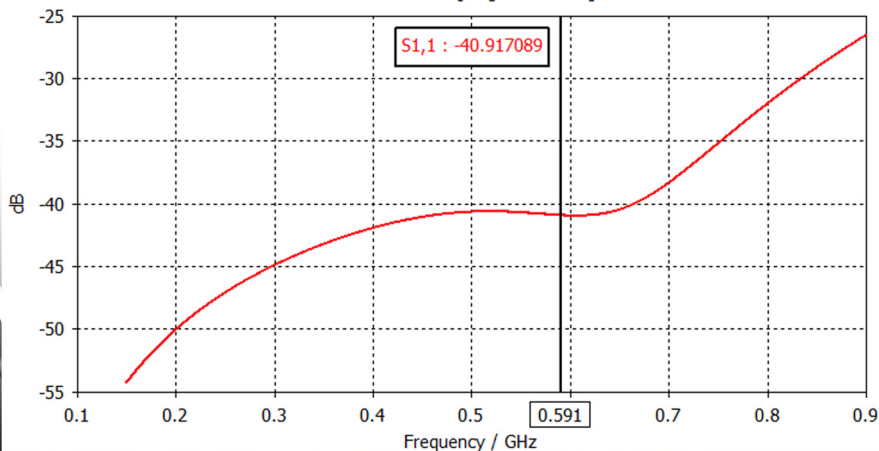


# EM results of EIC alumina FPC

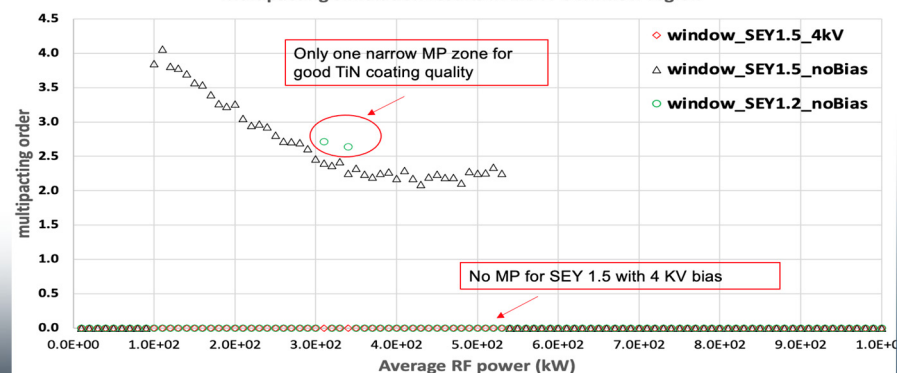


- Window material: 99.5 % alumina
- Broadband window design
- Field around window optimized to reduce MP and peak fields around braze/choke.
- MP simulations are encouraging:
  - With an ideal window TiN coating (SEY=1.2), we may not need bias.
  - We are designing the coupler to include an optional 4.5 kV DC bias, just in case.

S-Parameters [Magnitude in dB]

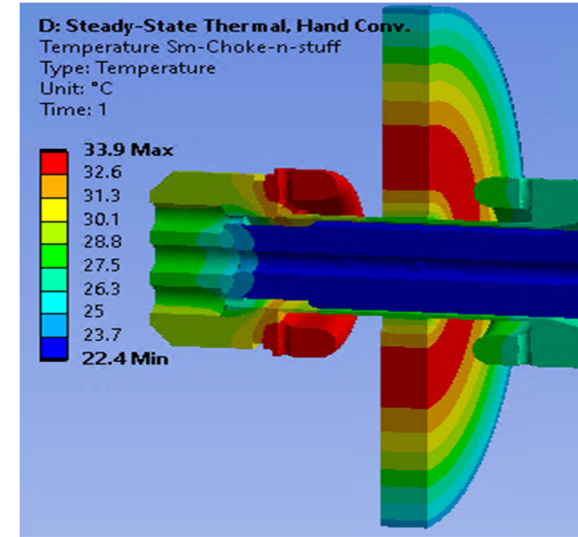
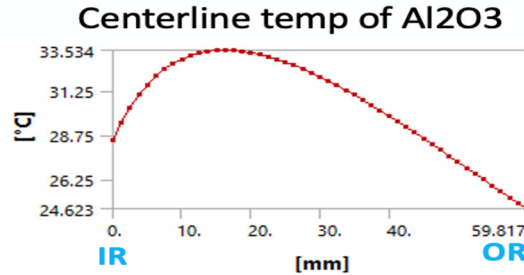
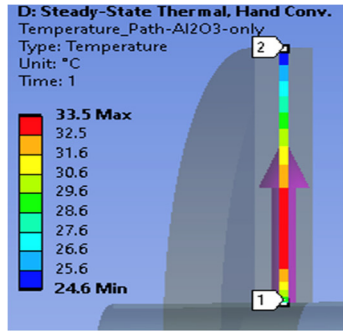


Multipacting Simulation results in EIC FPC window region



# Thermal and mechanical analysis of EIC alumina FPC

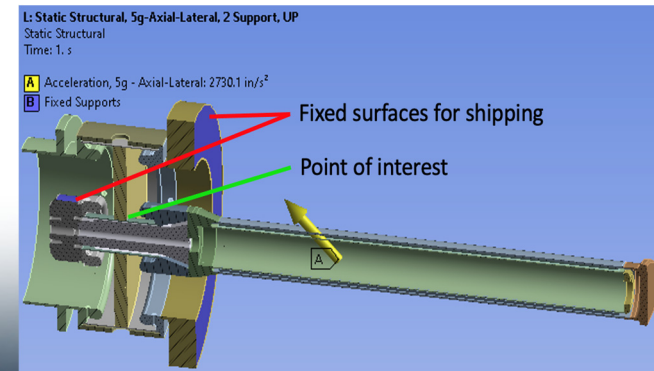
- RF-thermal-mechanical simulation results (1 MW, TW):
  - Maximum  $\Delta T$  in alumina ceramic is 10 C.
  - Highest temperature is 34 C on the chock joint tip.



- Mechanical robustness evaluated for handling and transportation
  - 1<sup>st</sup> mechanical modal frequency: 100 Hz
  - 5g shock load calculation results are encouraging

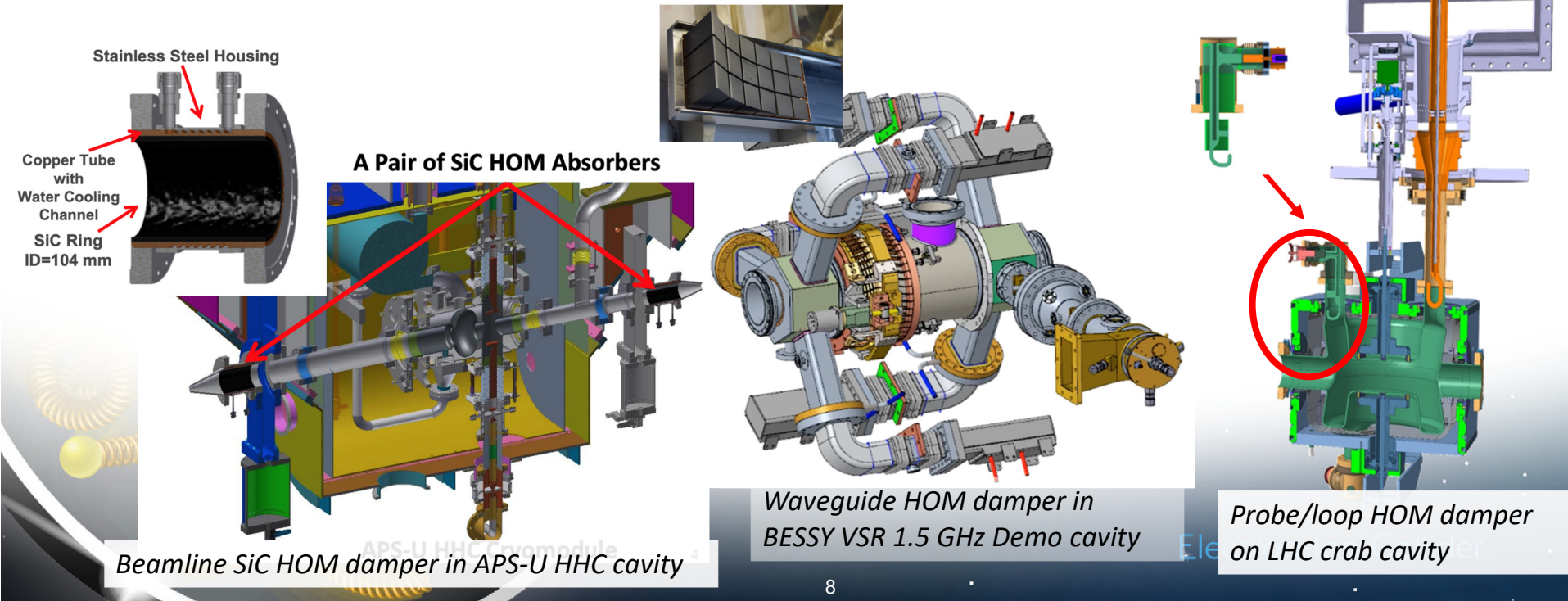
| ANSYS Simulation (5g)  | Max Equiv. Stress (Von-Mises) (all) (psi) | Max Equiv. Stress (Von-Mises) (copper) (psi) | Max. Principal Stress (Al <sub>2</sub> O <sub>3</sub> ) (psi) | Min. Principal Stress (Al <sub>2</sub> O <sub>3</sub> ) (psi) | Max. Lateral Deflection (inches) |
|------------------------|-------------------------------------------|----------------------------------------------|---------------------------------------------------------------|---------------------------------------------------------------|----------------------------------|
| Lateral / Axial toward | 4,773                                     | 4,312                                        | 4,936                                                         | -4,547                                                        | 0.0073                           |

Courtesy : Jesse Fite



# HOM damper for SRF cavities

- HOM plays a prominent role in determining accelerator limitations and beam quality.*
- Three main HOM dampers used on SRF cavities: beamline, waveguide and probe/loop HOM damper.*





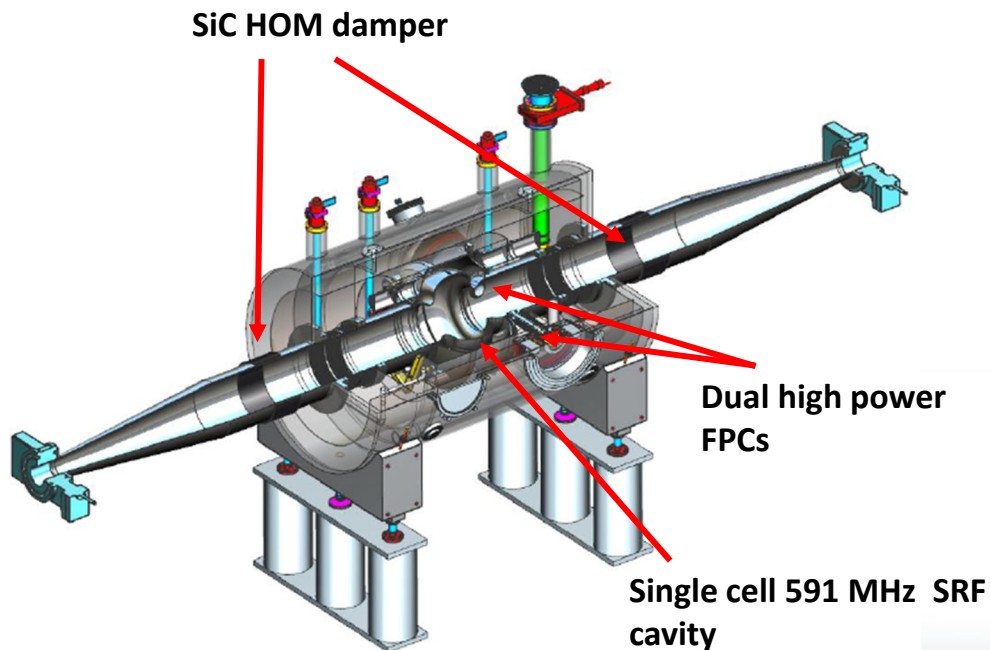
# Features of HOM dampers

| Type of HOM damper           | Bandwidth                                                          | Power               | Real estate space                                                     | cooling                   | Applications in Projects                                                         |
|------------------------------|--------------------------------------------------------------------|---------------------|-----------------------------------------------------------------------|---------------------------|----------------------------------------------------------------------------------|
| <i>Beampipe HOM damper</i>   | <i>Broadband (above beampipe's cutoff frequency )</i>              | <i>High</i>         | <i>Longitudinal space for thermal transition from 2/4K to 77/300k</i> | <i>Water or LN2</i>       | <i>KEK B, Cbeta<br/>APS-U SRF cavity,<br/>Euro XFEL<br/>LeREC booster cavity</i> |
| <i>Probe/loop HOM damper</i> | <i>Bandstop or high pass filter,<br/>Notches at high frequency</i> | <i>Low - medium</i> | <i>small</i>                                                          | <i>Conductive cooling</i> | <i>Euro XFEL<br/>LHC SRF cavities<br/>LCLS II</i>                                |
| <i>Waveguide HOM damper</i>  | <i>Broadband (above waveguide's cutoff frequency )</i>             | <i>High</i>         | <i>Large transversal space requirement</i>                            | <i>water</i>              | <i>CEBAF<br/>BESSY 1.5 GHz VSR<br/>bERLPro</i>                                   |

- SiC beampipe HOM damper was chosen for damping HOMs in EIC electron storage ring SRF cavity, which HOM power is up to 50 kW per cavity.

# HOM damping requirement for EIC ESR SRF cavity

## EIC ESR cryomodule concept design



Courtesy: Frank Marhauser and Jim Henry

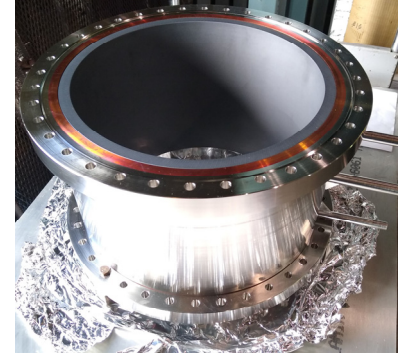
*Max. HOM power in EIC operating scenarios*

| Parameter                   | Value |
|-----------------------------|-------|
| Number of Bunches           | 1160  |
| Bunch Harmonic Number       | 1260  |
| Bunch Frequency [MHz]       | 98.5  |
| Energy [GeV]                | 10    |
| Particles per Bunch [1E10]  | 17.2  |
| Bunch Charge [nC]           | 27.6  |
| Bunch Length [mm]           | 8     |
| HOM Power [kW/cavity]       | 48.6  |
| HOM Power per Absorber [kW] | 24.3  |

- *EIC ESR needs 17x 591 MHz SRF cryomodules operating in all operating scenarios.*
- *Two SiC HOM dampers will share the HOM damper power in a cryomodule.*

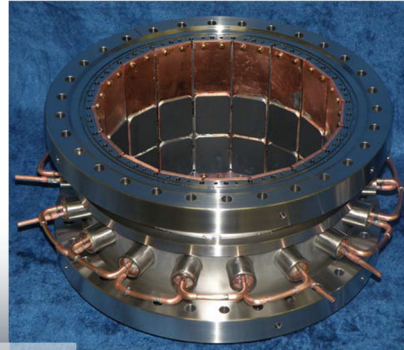
# Two prototype SiC HOM dampers

- Solid cylindrical SiC HOM damper

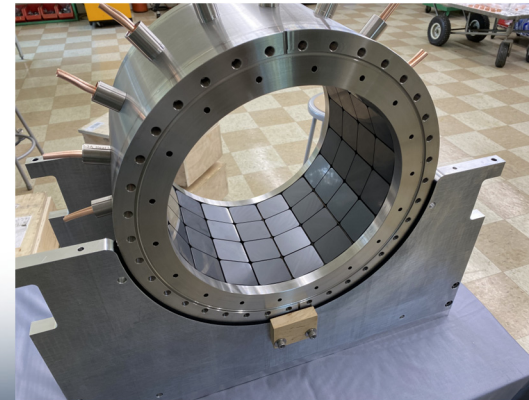


- Tile-style SiC HOM damper

*SBIR project with  
TJS Technologies LLC*



Courtesy: T. Schultheis

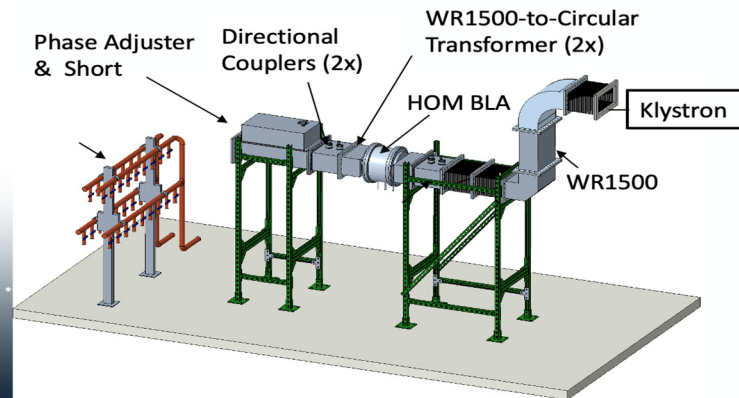
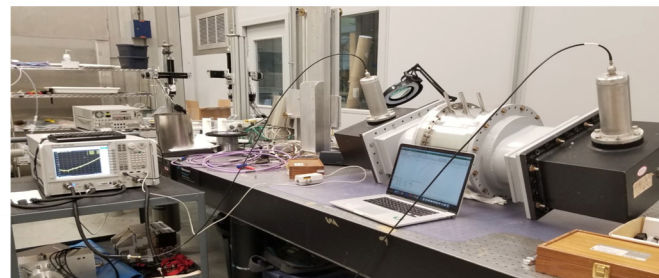
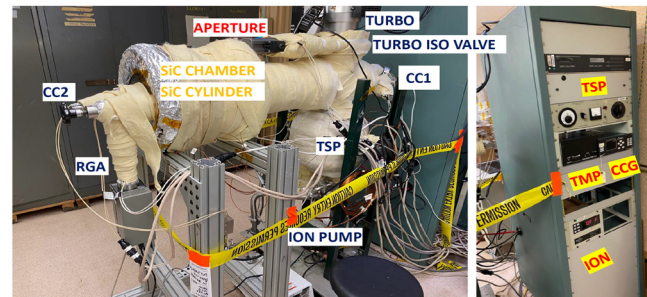


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# HOM damper test status and plan

- First outgassing test were completed with solid SiC HOM damper.
  - Outgassing rate is  $2.2\text{e-}10$  torr-liters/sec-cm<sup>2</sup>
  - Demonstrated interference-fit SiC assembly satisfies the high vacuum needs in EIC SRF cavities.
- Low power measurement on solid SiC HOM damper result is close to expectation. → We will need 62 kW to test the 24 kW absorption at 704 MHz.
- Next step:
  - Outgassing and low power measurement on tile-style SiC HOM damper
  - High power test at 704 MHz to verify power handling (dissipation = 24 kW)





# Closing Comments

- High power FPCs are used successfully in SRF cavity applications worldwide and are critical for the future success of high intensity accelerators.
  - FPC performance is evolving, driven by the need of high intensity accelerator.
  - Recent development of 1 MW/500 kW (TW/SW) FPCs are progressing and encouraging.
- HOM coupler development:
  - HOM dampers address a wide bandwidth and range of power levels for SRF cavities.
  - Status and plan of 24 kW SIC HOM damper absorbers for EIC eSR SRF cavity were presented.
- Future applications may need even more power and I am excited to see all developments in these areas.



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